12-05-2001

PATENTS DIRECTO THE H Please 101906	PATENTS ONLY ) TRADEMARKS . copy thereof
1. Name of conveyible party(ies)  Lukihiko KAGGEARA  Macanina IIII AMAMOTO  Takayuki SHIBAYAMA	Name and Address of receiving party(ies)     Name: DAIDO METAL COMPANY LTD.     Address: 2, Sanage-cho, Kita-ku     Nagoya, Japan
Additional name(s) of conveying party(ies) attached? [ ] Yes [XX] No	Additional name(s) & address(es) attached? [ ] Yes [XX] No
Nature of conveyance:  [x] Assignment [ ] Change of Name [ ] Security Agreement [ ] Merger  Execution Date: September 4, 2001	[ ] Other
Application number(s) or patent number(s). If this document	is being filed together with a new application, the execution date of
the application is:Date	
A. Patent Application No(s).  09/977,542	B. Patent No(s).
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Additional numbers attached? [ ] Yes [XX] No	
Name and address of party to whom correspondence concerning document should be mailed:	Number of applications and patents involved:     One ( 1 )
BROWDY AND NEIMARK, P.L.L.C. 624 Ninth Street, N.W. Suite 300	Amount of fee enclosed or authorized to be charged:     \$40.00
Washington, D.C. 20001-5303	8. PTO Form-2038 in the amount of \$40.00 is attached.
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<ol> <li>Statement and Signature.</li> <li>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</li> </ol>	
Norman J. Latker (Reg. No. 19,963)	N-tt 11/28/81
Name of Person Signing Signature Date	

NJL:kaw

PATENT REEL: 012330 FRAME: 0551

Total number of pages including cover sheet [03]

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## **ASSIGNMENT**

As a below named inventor, I hereby declare that:

**RECORDED: 11/29/2001** 

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by DAIDO METAL COMPANY LTD., a corporation organized under the laws of Japan, located at 2, Sanage-cho, Kita-ku, Nagoya, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said DAIDO METAL COMPANY LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

"MULTI-LAYERED PLAIN BEARING AND PRODUCING METHOD THEREOF"

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said DAIDO METAL COMPANY LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fullyand entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said DAIDO METAL COMPANY LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

Date Signed
WITNESSES
(発明者フルネームサイン)

Vukihiko Kagohara

September 4, 2001

Vukihiko KAGOHARA

2)

Asahi'to Fai''da September 4, 2001

Masahito FUJITA

3)

Kulchi' Yamamoto

Koichi Yamamoto

Koichi Yamamoto

Takayuki Shibayama

Takayuki Shibayama

Takayuki SHIBAYAMA

5)

6)

6)

PATENT REEL: 012330 FRAME: 0552